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**ADS7866 ADS7867 ADS7868**

# **1.2-V, 12-/10-/8-BIT, 200-KSPS/100-KSPS, MICRO-POWER, MINIATURE ANALOG-TO-DIGITAL CONVERTER WITH SERIAL INTERFACE**

#### **FEATURES**

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**Burr-Brown Products** from Texas Instruments

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- **(ADS7866)** delays associated with the device.
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- **6-Pin SOT-23 Package** SCLK frequency.

#### **APPLICATIONS**

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- **Isolated Data Acquisition**
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- **Portable Data Acquisition Systems**
- **Automatic Test Equipment**

### **DESCRIPTION**

The ADS7866/67/68 are low power, miniature, 12/10/8-bit A/D converters each with a unipolar, single-ended input. These devices can operate from a single 1.6 V to 3.6 V supply with a 200-KSPS throughput for ADS7866. In addition, these devices can maintain at least a 100-KSPS throughput with a supply as low as 1.2 V.

The sampling, conversion, and activation of digital **Single 1.2-V to 3.6-V Supply Operation** output SDO are initiated on the falling edge of  $\overline{CS}$ .<br> **High Throughput High Throughput SCLK** is used for controlling the converter conversion rate and shifting data out of the converter. **– 200/240/280KSPS for 12/10/8-Bit V<sub>DD</sub> ≥ 1.6 V** Furthermore, SCLK provides a mechanism to allow<br>
– 100/120/140KSPS for 12/10/8-Bit V<sub>-2</sub> > 1.2 V digital host processors to synchronize with the con**digital host processors to synchronize with the con- – 100/120/140KSPS for 12/10/8-Bit V<sub>DD</sub> ≥ 1.2 V** and verter. These converters interface with converters • ±**1.5LSB INL, 12-Bit NMC (ADS7866)** micro-processors or DSPs through a high-speed SPI  $compatible$  serial interface. There are no pipeline

**Synchronized Conversion with SCLK** The minimum conversion time is determined by the **• SPI Compatible Serial Interface** frequency of the serial clock input, SCLK, while the serial clock input, SCLK, while the maximum frequency of SCLK is determined by the **No Pipeline Delays**<br> **No Pipeline Delays No Pipeline Delays** minimum sampling time required to charge the input<br> **Low Power canacitance** to 12/10/8-bit accuracy for the capacitance to 12/10/8-bit accuracy for the **– 1.39 mW Typ at 200 KSPS, V<sub>DD</sub> = 3.6 V** ADS7866/67/68, respectively. The maximum  $-$  0.39 mW Typ at 200 KSPS,  $V_{DD} = 1.6$  V throughput is determined by how often a conversion is initiated when the minimum sampling time is met<br> **– 0.22 mW Typ at 100 KSPS, V<sub>DD</sub>** = 1.2 V and the maximum SCLK frequency is used. Each<br> **Auto Power-Down: 8 nA Typ. 300 nA Max** device automatically powers down after ea device automatically powers down after each conver-**0 V to V<sub>DD</sub> Unipolar Input Range** • **1989** • Sion, which allows each device to save power when the throughput is reduced while using the maximum

The converter reference is taken internally from the supply. Hence, the analog input range for these **Battery Powered Systems** devices is 0 V to V<sub>DD</sub>.

These devices are available in a 6-pin SOT-23 • **Medical Instruments** package and are characterized over the industrial **Portable Communication**<br>-40°C to 85°C temperature range.



#### **Micro-Power Miniature SAR Converter Family**





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

## **ADS7866 ADS7867 ADS7868**



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

#### **ORDERING INFORMATION(1)**



(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

## **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range (unless otherwise noted)



### **SPECIFICATIONS, ADS7866**

At –40°C to 85°C,  $\rm f_{SAMPLE}$  = 200 KSPS and  $\rm f_{SCLK}$  = 3.4 MHz if 1.6 V  $\leq$  V<sub>DD</sub>  $\leq$  3.6 V;  $\rm f_{SAMPLE}$  = 100 KSPS and  $\rm f_{SCLK}$  = 1.7 MHz if 1.2  $V \leq V_{DD}$  < 1.6 V (unless otherwise noted)



(1) LSB = Least Significant BIt

(3) The difference in the last code transition 011...111 to 111...111 from the ideal value of  $V_{DD}$  - 1 LSB with the offset error removed.<br>(4) The absolute difference from the ideal transfer function of the converter. Th

The absolute difference from the ideal transfer function of the converter. This specification is similar to INL error except the effects of offset error and gain error are included.

- (5) The 2nd through 10th harmonics are used to determine THD.
- (6) Input frequency where the amplitude of the digitized signal has decreased by 0.1 dB or 3 dB.
- (7) Ideal input span which does not include gain or offset errors.

<sup>(2)</sup> The difference in the first code transition 000...000 to 000...001 from the ideal value of GND + 1 LSB.



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#### **SPECIFICATIONS, ADS7866 (continued)**

At –40°C to 85°C, f<sub>SAMPLE</sub> = 200 KSPS and f<sub>SCLK</sub> = 3.4 MHz if 1.6 V ≤ V<sub>DD</sub> ≤ 3.6 V; f<sub>SAMPLE</sub> = 100 KSPS and f<sub>SCLK</sub> = 1.7 MHz if 1.2  $V \leq V_{DD}$  < 1.6 V (unless otherwise noted)



### **SPECIFICATIONS, ADS7867**

At –40°C to 85°C, f<sub>SAMPLE</sub> = 240 KSPS and f<sub>SCLK</sub> = 3.4 MHz if 1.6 V ≤ V<sub>DD</sub> ≤ 3.6 V; f<sub>SAMPLE</sub> = 120 KSPS and f<sub>SCLK</sub> = 1.7 MHz if 1.2  $V \leq V_{DD}$  < 1.6 V (unless otherwise noted)



(1) LSB = Least Significant BIt

(3) The difference in the last code transition 011...111 to 111...111 from the ideal value of  $V_{DD}$  - 1 LSB with the offset error removed.<br>(4) The absolute difference from the ideal transfer function of the converter. Th

The absolute difference from the ideal transfer function of the converter. This specification is similar to INL error except the effects of offset error and gain error are included.

- (5) The 2nd through 10th harmonics are used to determine THD.
- (6) Input frequency where the amplitude of the digitized signal has decreased by 0.1 dB or 3 dB.
- Ideal input span which does not include gain or offset errors.

 $(2)$  The difference in the first code transition 000...000 to 000...001 from the ideal value of GND + 1 LSB.



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#### **SPECIFICATIONS, ADS7867 (continued)**

At –40°C to 85°C, f<sub>SAMPLE</sub> = 240 KSPS and f<sub>SCLK</sub> = 3.4 MHz if 1.6 V ≤ V<sub>DD</sub> ≤ 3.6 V; f<sub>SAMPLE</sub> = 120 KSPS and f<sub>SCLK</sub> = 1.7 MHz if 1.2  $V \leq V_{DD}$  < 1.6 V (unless otherwise noted)



#### **SPECIFICATIONS, ADS7868**

At –40°C to 85°C, f<sub>SAMPLE</sub> = 280 KSPS and f<sub>SCLK</sub> = 3.4 MHz if 1.6 V ≤ V<sub>DD</sub> ≤ 3.6 V; f<sub>SAMPLE</sub> = 140 KSPS and f<sub>SCLK</sub> = 1.7 MHz if 1.2  $V \leq V_{DD}$  < 1.6 V (unless otherwise noted)



(1) LSB = Least Significant BIt

- (5) The 2nd through 10th harmonics are used to determine THD.
- (6) Input frequency where the amplitude of the digitized signal has decreased by 0.1 dB or 3 dB.
- (7) Ideal input span which does not include gain or offset errors.

<sup>(2)</sup> The difference in the first code transition 000...000 to 000...001 from the ideal value of GND + 1 LSB.

<sup>(3)</sup> The difference in the last code transition 011...111 to 111...111 from the ideal value of  $V_{DD}$  - 1 LSB with the offset error removed.<br>(4) The absolute difference from the ideal transfer function of the converter. Th

The absolute difference from the ideal transfer function of the converter. This specification is similar to INL error except the effects of offset error and gain error are included.



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## **SPECIFICATIONS, ADS7868 (continued)**

At –40°C to 85°C, f<sub>SAMPLE</sub> = 280 KSPS and f<sub>SCLK</sub> = 3.4 MHz if 1.6 V ≤ V<sub>DD</sub> ≤ 3.6 V; f<sub>SAMPLE</sub> = 140 KSPS and f<sub>SCLK</sub> = 1.7 MHz if 1.2  $V \leq V_{DD}$  < 1.6 V (unless otherwise noted)



## <span id="page-8-0"></span>**TIMING REQUIREMENTS(1)(2)**

At –40°C to 85°C, f<sub>scLK</sub> = 3.4 MHz if 1.6 V ≤ V<sub>DD</sub> ≤ 3.6 V; f<sub>scLK</sub> = 1.7 MHz if 1.2 V ≤ V<sub>DD</sub> < 1.6 V, 50-pF Load on SDO Pin, unless otherwise noted



(1) All input signals are specified with  $t_r = t_f = 5$  ns (10% to 90% of  $V_{DD}$ ) and timed from a voltage level of  $(V_{IL} + V_{IH})/2$ .<br>(2) See timing diagram in Figure 1.

(2) See timing diagram in Figure 1.<br>(3) Min  $t_{C(SCLK)}$  is determined by the (3) Min t<sub>C(SCLK)</sub> is determined by the Min t<sub>SAMPLE</sub> of the specific resolution and supply voltage. See *Acquisition Time, Conversion Time, and*<br>Total Cycle Time section for further details.



**Figure 1. Timing Diagram**

#### **PIN CONFIGURATION**



#### **TERMINAL FUNCTIONS**





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#### **TYPICAL CHARACTERISTICS ADS7866 (continued)**



### **TYPICAL CHARACTERISTICS ADS7866 (continued)**



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#### **TYPICAL CHARACTERISTICS ADS7866 (continued)**









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## **THEORY OF OPERATION**

The ADS7866/67/68 is a family of low supply voltage, low power, high-speed successive approximation register (SAR) analog-to-digital converters (ADCs). The devices can be operated from a supply range from 1.2 V to 3.6 V. There is no need for an external reference. The reference is derived internally from the supply voltage, so the analog input range can be from 0 V to  $V_{DD}$ . These ADCs use a charge redistribution architecture, which inherently includes a sample/hold function.

## **START OF A CONVERSION CYCLE**

A conversion cycle is initiated by bringing the  $\overline{CS}$  pin low and supplying the serial clock SCLK. The time between the falling edge of  $\overline{CS}$  and the third falling edge of SCLK after  $\overline{CS}$  falls is used to acquire the input signal. This must be greater than or equal to the minimum acquisition time (MIN  $t_{SAMPE}$  in [Table 1\)](#page-17-0) specified for the desired resolution and supply voltage. On the third falling edge of SCLK after CS falls, the device goes into hold mode and the process of digitizing the sampled input signal starts.

#### **Acquisition Time, Conversion Time, and Total Cycle Time**

The maximum SCLK frequency is determined by the minimum acquisition time (MIN  $t_{SAMPLE}$ ) specified for the specific resolution and supply voltage of the device. The conversion time is determined by the frequency of SCLK since this is a synchronous converter. The conversion time is 13 times the SCLK cycle time  $t_{C(SCLK)}$  for the ADS7866, 11 times for the ADS7867, and 9 times for the ADS7868. The acquisition time, which is also the power up time, is the set-up time between the first falling edge of SCLK after CS falls ( $t_{\text{SUCSF-FSCLKF}}$ ) plus 2 times  $t_{C(SCLK)}$ .

The total cycle time,  $t_{\text{CYCI E}}$ , which is the inverse of the maximum sample rate, can be calculated as follows:

 $t_{\text{CYCLE}} = t_{\text{SAMPLE}} + t_{\text{CONVERT}} + 0.5 \times t_{\text{C(SCLR)}}$ if  $t_{DIS(EOC\text{-}SDOZ)} + t_{SU(LSBZ\text{-}CSF)} \leq 0.5 \times t_{C(SCLK)}$  $t_{\text{CYCLE}} = t_{\text{SAMPLE}} + t_{\text{CONVERT}} + t_{\text{DIS(EOC-SDOZ)}} + t_{\text{SULS BZ-CSF}}$ if  $t_{DIS(EOC-SDOZ)} + t_{SUI(LSBZ-CSF)} > 0.5 \times t_{C(SCLK)}$ 



#### <span id="page-17-0"></span>**THEORY OF OPERATION (continued)**





#### **TYPICAL CONNECTION**

For a typical connection circuit for the ADS7866/67/68 see Figure 27. A REF3112 is used to supply 1.2 V to the device. A 0.1- $\mu$ F decoupling capacitor is required between the REF/V<sub>DD</sub> and GND pins of the converter. This capacitor should be placed as close as possible to the pins of the device. Designers should strive to minimize the routing length of the traces that connect the terminals of the capacitor to the pins of the converter.

Keep in mind the converter offers no inherent rejection of noise or voltage variation in regards to the reference input. This is of particular concern because the reference input is tied to the power supply. Any noise and ripple from the supply appears directly in the digital results. While high frequency noise can be filtered out as described in the previous paragraph, voltage variation due to the line frequency (50 Hz or 60 Hz) can be difficult to remove.





### **ANALOG INPUT**

Figure 28 shows the analog input equivalent circuit for the ADS7866/67/68. The analog input is provided between the VIN and GND pins. When a conversion is initiated, the input signal is sampled on the internal capacitor array. When the converter enters hold mode, the input signal is captured on the internal capacitor array. The VIN input range is limited to 0 V to  $V_{DD}$  because the reference is derived from the supply.

The current flowing into the analog input depends upon a number of factors, such as the sample rate, the input voltage, and the input source impedance. The current from the input source charges the internal capacitor array during the sample period. After this capacitance has been fully charged, there is no further input current. The source of the analog input voltage must be able to charge the input capacitance  $C_S$  (12 pF typical) within the minimum acquisition time (MIN t<sub>SAMPLE</sub>) specified for the desired resolution and supply voltage. In the case of the ADS7866, the MIN t<sub>SAMPLE</sub> for 12-bit resolution is 643 ns (V<sub>DD</sub> between 1.6 V and 3.6 V). When the converter goes into hold mode, the input impedance is greater than 1 G $\Omega$ .

Care must be taken regarding the absolute analog input voltage. In order to maintain the linearity of the converter, the span (VIN – GND) should be within the limits specified. Outside of these limits, the converter's linearity may not meet specifications. Noise introduced into the converter from the input source may be minimized by using low bandwidth input signals along with low-pass filters.



**Figure 28. Analog Input Equivalent Circuit (Typical Impedance Values at V<sub>DD</sub> = 1.6 V, T<sub>A</sub> = 27°C)** 

#### **Choice of Input Driving Amplifier**

The analog input to the converter needs to be driven with a low noise, low voltage op amp like the OPA364 or OPA333. An RC filter is recommended at the input pin to low-pass filter the noise from the source. The input to the converter is a unipolar input voltage in the range 0 V to  $V_{DD}$ .

### **DIGITAL INTERFACE**

The ADS7866/67/68 interface with microprocessors or DSPs through a high-speed SPI compatible serial interface with CPOL = 1 (inactive SCLK returns to logic high or SCLK leading edge is the rising edge), CPHA = 1 (output data changes on falling edge of SCLK and is available on the rising edge of SCLK). The sampling, conversion, and activation of SDO are initiated on the falling edge of  $\overline{CS}$ . The serial clock (SCLK) is used for controlling the rate of conversion. It also provides a mechanism allowing synchronization with digital host processors.

The digital inputs,  $\overline{CS}$  and SCLK, can exceed the supply voltage  $V_{DD}$  as long as they do not exceed the maximum  $V_{\text{H}}$  of 3.6 V. This allows the ADS7866/67/68 family to interface with host processors which use a different supply voltage than the converter without requiring external level-shifting circuitry. Furthermore, the digital inputs can be applied to  $\overline{CS}$  and SCLK before the supply voltage of the converter is activated without the risk of creating a latch-up condition.

#### **Conversion Result**

The ADS7866/67/68 outputs 12/10/8-bit data after 4 leading zeros, respectively. These codes are in straight binary format as shown in [Table 2](#page-19-0).

### <span id="page-19-0"></span>**ADS7866 ADS7867 ADS7868** SLAS465–JUNE 2005

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#### **Table 2. ADS7866/67/68 Ideal Output Codes Versus Input Voltages**

## **POWER DISSIPATION**

The ADS7866/67/68 family is capable of operating with very low supply voltages while drawing a fraction of a milliamp. Furthermore, there is an auto power-down mode to reduce the power dissipation between conversion cycles. Carefully selected system design can take advantage of these features to achieve optimum power performance.

### **Auto Power-Down Mode**

The ADS7866/67/68 family has an auto power-down feature. Besides powering down all circuitry, the converter consumes only 8 nA typically in this mode. The device automatically wakes up when CS falls. However, not all of the functional blocks are fully powered until sometime before the third falling edge of SCLK. The device powers down once it reaches the end of conversion (EOC) which is the 16th falling edge of SCLK for the ADS7866 (the 14th and 12th for the ADS7867 and ADS7868, respectively). If  $\overline{CS}$  is pulled high before the device reaches the EOC, the converter goes into power-down mode and the ongoing conversion is aborted. Refer to the timing diagram in [Figure 1](#page-8-0) for further information.

#### **Power Saving: SCLK Frequency and Throughput**

These converters achieve lower power dissipation for a fixed throughput rate  $f_{sample} = 1/t_{cycle}$  by using higher SCLK frequencies. Higher SCLK frequencies reduce the acquisition time  $(t_{sample})$  and conversion time  $(t_{convert})$ . This means the converters spend more time in auto power-down mode per conversion cycle. This can be observed in [Figure 8](#page-11-0) which shows the ADS7866 supply current versus SCLK frequency for  $f_{sample} = 100$  KSPS. For a particular SCLK frequency, the acquisition time and conversion time are fixed. Therefore, a lower throughput increases the proportion of the time the converters are in power down. [Figure 10](#page-11-0) shows this case for the ADS7866 power consumption versus throughput rate for  $f_{SCLK} = 3.4$  MHz.

### **Power-On Initialization**

There is no specific initialization requirement for these converters after power-on, but the first conversion might not yield a valid result. In order to set the converter in a known state,  $\overline{\text{CS}}$  should be toggled low then high after  $\rm V_{DD}$  has stabilized during power-on. By doing this, the converter is placed in auto power-down mode, and the serial data output (SDO) is 3-stated.



### **PACKAGING INFORMATION**



**(1)** The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

**(3)** MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**(4)** There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

**(5)** Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



## **PACKAGE OPTION ADDENDUM**

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# **PACKAGE MATERIALS INFORMATION**

Texas<br>Instruments

## **TAPE AND REEL INFORMATION**





### **QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**





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# **PACKAGE MATERIALS INFORMATION**

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\*All dimensions are nominal





# **PACKAGE OUTLINE**

# **DBV0006A SOT-23 - 1.45 mm max height**

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.25 per side.
- 4. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
- 5. Refernce JEDEC MO-178.



# **EXAMPLE BOARD LAYOUT**

# **DBV0006A SOT-23 - 1.45 mm max height**

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# **EXAMPLE STENCIL DESIGN**

# **DBV0006A SOT-23 - 1.45 mm max height**

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



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